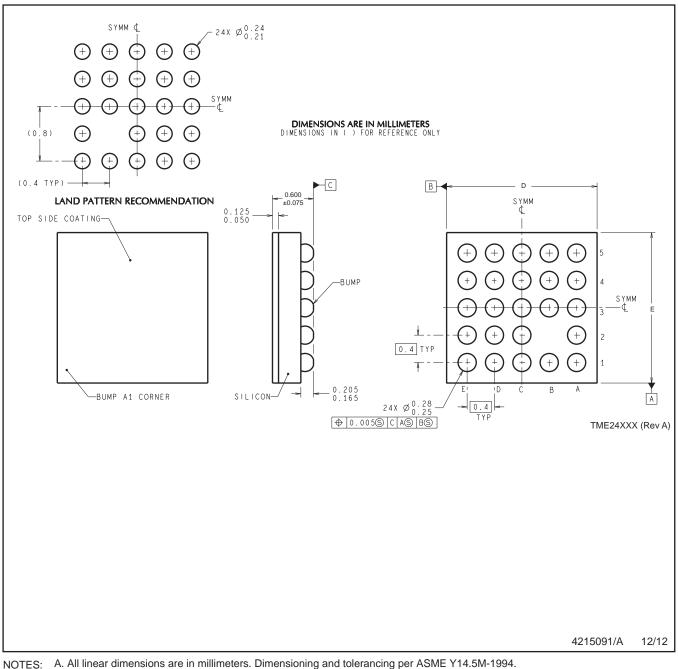
## YFR0024



B. This drawing is subject to change without notice.



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